

APPLICATION DATA SHEET**Application Information**

Application number::

Filing Date::

December 19, 2001

Application Type::

Regular

Subject Matter::

Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?::

No

Number of CD disks::

Number of copies of CDs::

Sequence submission?::

No

Computer Readable Form (CRF)?::

No

Number of copies of CRF::

Title ::

PROCESS FOR MANUFACTURING
 INTEGRATED DEVICES HAVING
 CONNECTIONS ON A SEPARATE WAFER,
 AND INTEGRATED DEVICE THUS OBTAINED

Attorney Docket Number::

854063.665

Request for Early Publication?::

No

Request for Non-Publication?::

No

Suggested Drawing Figure::

Total Drawing Sheets::

8

Small Entity?::

No

Petition included?::

No

Petition Type::

Licensed U.S. Gov't Agency::

Contract or Grant No::

Secrecy Order in Parent Appl.?::

No

First Applicant Information

Applicant Authority Type:: Inventor
 Primary Citizenship Country:: Italy
 Status:: Full Capacity
 Given Name:: Ubaldo
 Middle Name::
 Family Name:: Mastromatteo
 Name Suffix::
 City of Residence:: Bareggio
 State or Province of Residence::
 Country of Residence:: Italy
 Street of mailing address:: Via Santo Stefano, 27
 City of mailing address:: Bareggio
 State or Province of mailing address::
 Country of mailing address:: Italy
 Postal or Zip Code of mailing address:: I-20010

10037435-121301

Correspondence InformationCorrespondence Customer Number :: **00500****Representative Information**

Representative Customer Number::		00500
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Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Europe	00830867.8	12/29/00	Yes

Assignee Information

Assignee name::	STMicroelectronics S.r.l.
Street of mailing address::	Via C. Olivetti, 2
City of mailing address::	Agrate Brianza
State or Province of mailing address::	
Country of mailing address::	Italy
Postal or Zip Code of mailing address::	I-20041